



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IFW

Applicant: Leonard Forbes et al.

Title: STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

Docket No.: 1303.109US1

Serial No.: 10/623,788

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Examiner: Pamela E. Perkins

Group Art Unit: 2822

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450


We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ Return postcard.
- ☒ Response to Restriction Requirement (15 pgs.).
- ☒ Communication Concerning Related Applications (1 pg.).
- ☒ Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (1 pg.), and copies of 2 cited documents.

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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By: 
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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 31 day of October, 2005.

KACIA LEE
Name

Kacia Lee
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)